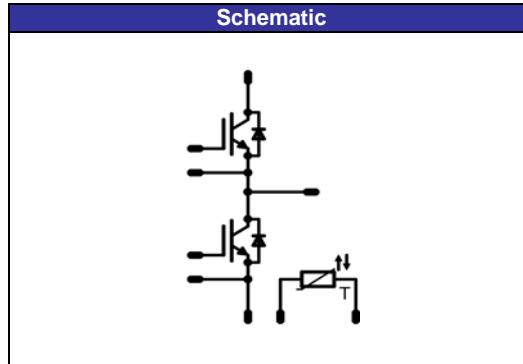


flowPHASE 3
1200V/450A

Features
<ul style="list-style-type: none"> • High Power screw contacts • Low loss Trench Fieldstop Technology IGBT • High Current Density FRED



Target Applications
<ul style="list-style-type: none"> • Motor Drives • Power Generation • Uninterruptable Power Supply



Types
<ul style="list-style-type: none"> • V23990-P660-F02 • V23990-P669-F02

Maximum Ratings
 $T_j=25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
-----------	--------	-----------	-------	------

Transistor Inverter

Collector-emitter break down voltage	V_{CE}		1200	V
DC collector current	I_C	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	350 455	A
Repetitive peak collector current	I_{Cpuls}	tp limited by $T_{j\max}$	1350	A
Power dissipation per IGBT	P_{tot}	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	748 1134	W
Gate-emitter peak voltage	V_{GE}		± 20	V
Short circuit ratings	t_{sc} V_{CC}	$T_j \leq 125^\circ\text{C}$ $V_{GE}=15\text{V}$	10 900	μs V
Maximum Junction Temperature	$T_{j\max}$		150	$^\circ\text{C}$

Diode Inverter

Peak Repetitive Reverse Voltage	V_{RRM}		1200	V
DC forward current	I_F	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	294 384	A
Repetitive peak forward current	I_{FRM}	tp limited by $T_{j\max}$	900	A
Power dissipation per Diode	P_{tot}	$T_j=T_{j\max}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	491 744	W
Maximum Junction Temperature	$T_{j\max}$		150	$^\circ\text{C}$

Maximum Ratings

T_j=25°C, unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
-----------	--------	-----------	-------	------

Thermal properties

Storage temperature	T _{stg}		-40...+125	°C
Operation temperature	T _{jop}		-40...+125	°C

Insulation properties

Insulation voltage	V _{is}	t=2s	DC voltage	4000	V
Creepage distance				min 12,7	mm
Clearance				min 12,7	mm

Characteristic Values

Parameter	Symbol	Conditions				Value			Unit
		$V_{GE}(V)$ or $V_{GS}(V)$	$V_r(V)$ or $V_{CE}(V)$ or $V_{DS}(V)$	$I_c(A)$ or $I_F(A)$ or $I_b(A)$	$T(^\circ C)$	Min		Max	

Transistor Inverter

Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$		0,018	$T_j=25^\circ C$ $T_j=125^\circ C$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15	450	$T_j=25^\circ C$ $T_j=125^\circ C$	1,3	2,06 2,43	2,3	V
Collector-emitter cut-off current incl. Diode	I_{CES}		0	1200	$T_j=25^\circ C$ $T_j=125^\circ C$			0,25	mA
Gate-emitter leakage current	I_{GES}		30	0	$T_j=25^\circ C$ $T_j=125^\circ C$			650	nA
Integrated Gate resistor	R_{gint}						1,67		Ohm
Turn-on delay time	$t_{d(on)}$	$R_{goff}=2 \Omega$ $R_{gon}=2 \Omega$	± 15	600	450	$T_j=25^\circ C$ $T_j=125^\circ C$		422	ns
Rise time	t_r					$T_j=25^\circ C$ $T_j=125^\circ C$		48,6	ns
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ C$ $T_j=125^\circ C$		614,4	ns
Fall time	t_f					$T_j=25^\circ C$ $T_j=125^\circ C$		146,4	ns
Turn-on energy loss per pulse	E_{on}					$T_j=25^\circ C$ $T_j=125^\circ C$		31,3	mWs
Turn-off energy loss per pulse	E_{off}					$T_j=25^\circ C$ $T_j=125^\circ C$		54,2	mWs
Input capacitance	C_{ies}						32,3		nF
Output capacitance	C_{oss}	$f=1MHz$	0	25		$T_j=25^\circ C$		1,689	nF
Reverse transfer capacitance	C_{rss}							1,464	nF
Gate charge	Q_{Gate}					$T_j=25^\circ C$		3700	nC
Thermal resistance chip to heatsink per chip	R_{thJH}	Thermal grease thickness≤50um $\lambda = 0,61 \text{ W/mK}$						0,095	K/W
Thermal resistance chip to case per chip	R_{thJC}							0,063	K/W

Diode Inverter

Diode forward voltage	V_F			450	$T_j=25^\circ C$ $T_j=125^\circ C$	1	1,96 2,04	2,4	V
Peak reverse recovery current	I_{RRM}	$R_{gon}=2 \Omega$	± 15	600	450	$T_j=25^\circ C$ $T_j=125^\circ C$		598,13	A
Reverse recovery time	t_{rr}					$T_j=25^\circ C$ $T_j=125^\circ C$		340,9	ns
Reverse recovered charge	Q_{rr}					$T_j=25^\circ C$ $T_j=125^\circ C$		82,94	mC
Peak rate of fall of recovery current	$di(rec)max/dt$					$T_j=25^\circ C$ $T_j=125^\circ C$		7944	A/ms
Reverse recovered energy	E_{rec}					$T_j=25^\circ C$ $T_j=125^\circ C$		36,011	mWs
Thermal resistance chip to heatsink per chip	R_{thJH}							0,146	K/W
Thermal resistance chip to case per chip	R_{thJC}							0,096	K/W

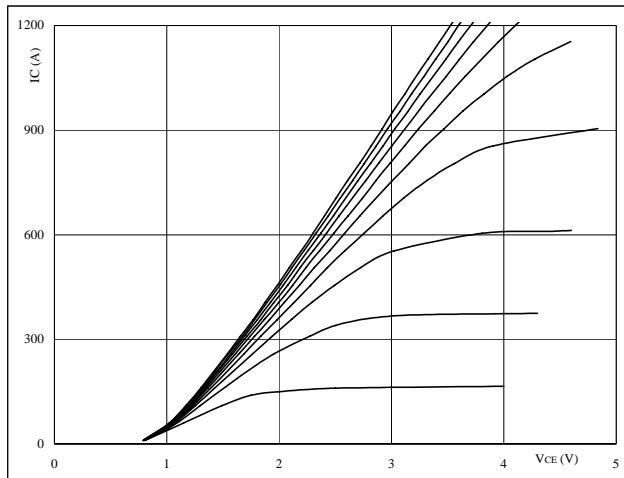
Thermistor

Rated resistance	R_{25}	Tol. ±5%				$T_j=25^\circ C$	4,2	4,7	5,8	kOhm
Deviation of R100	D_{RR}	$R100=435\Omega$				$T_c=100^\circ C$		2,6		%/K
Power dissipation given Epcos-Typ	P					$T_j=25^\circ C$			210	mW
B-value	$B_{(25/100)}$	Tol. ±3%				$T_j=25^\circ C$		3530		K

Output Inverter

Figure 1
Typical output characteristics

$$I_C = f(V_{CE})$$


At

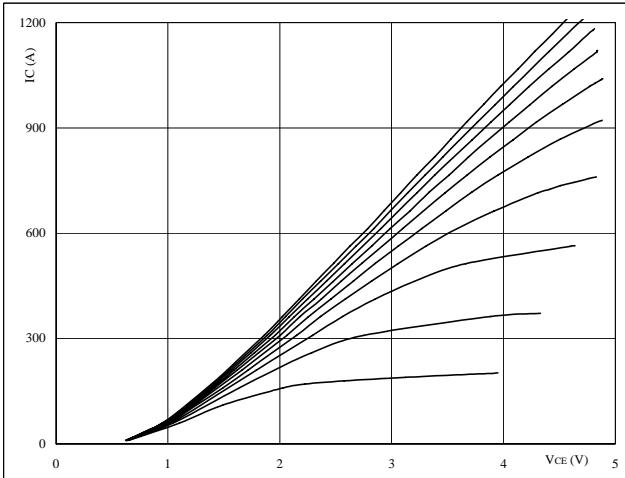
$$t_p = 250 \mu\text{s}$$

$$T_j = 25^\circ\text{C}$$

VGE from 8 V to 17 V in steps of 1 V

Figure 2
Typical output characteristics

$$I_C = f(V_{CE})$$


At

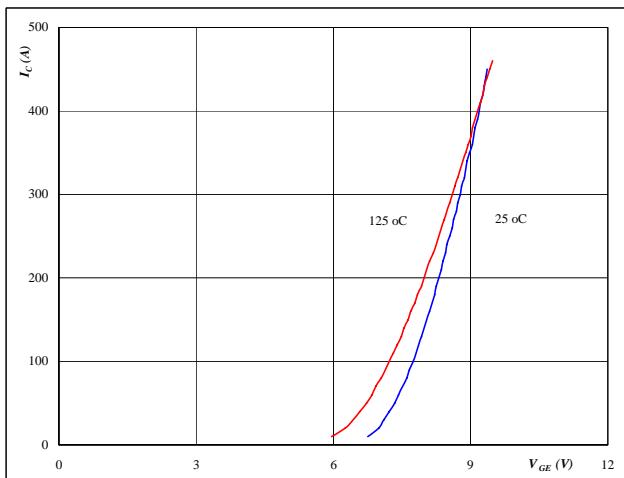
$$t_p = 250 \mu\text{s}$$

$$T_j = 125^\circ\text{C}$$

VGE from 8 V to 17 V in steps of 1 V

Figure 3
Output inverter IGBT
Typical transfer characteristics

$$I_C = f(V_{GE})$$

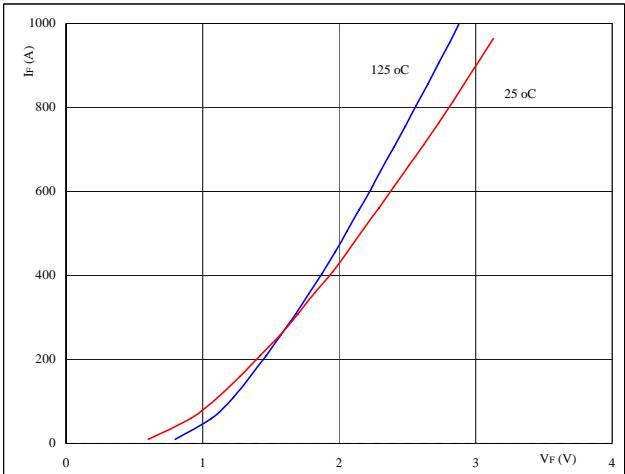

At

$$t_p = 250 \mu\text{s}$$

$$V_{CE} = 10 \text{ V}$$

Figure 4
Output inverter FRED
Typical diode forward current as
a function of forward voltage

$$I_F = f(V_F)$$


At

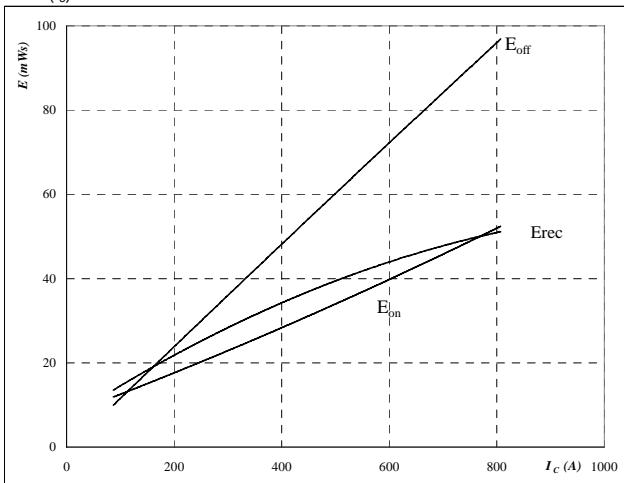
$$t_p = 250 \mu\text{s}$$

Output Inverter

Figure 5

**Typical switching energy losses
as a function of collector current**

$$E = f(I_C)$$



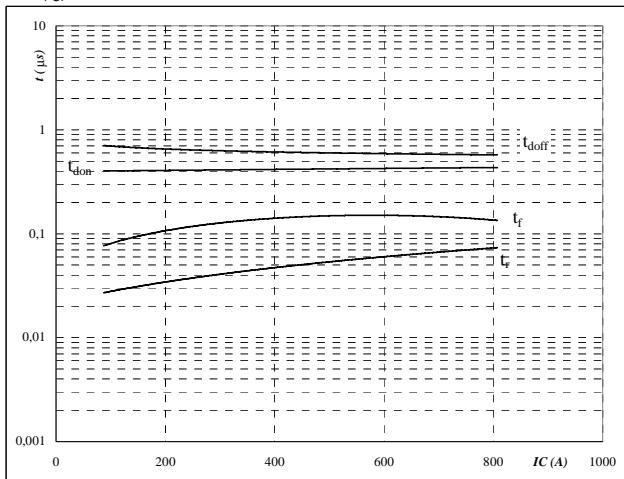
With an inductive load at

$$\begin{aligned} T_j &= 125 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 2 \quad \Omega \\ R_{goff} &= 2 \quad \Omega \end{aligned}$$

Figure 7

**Typical switching times as a
function of collector current**

$$t = f(I_C)$$



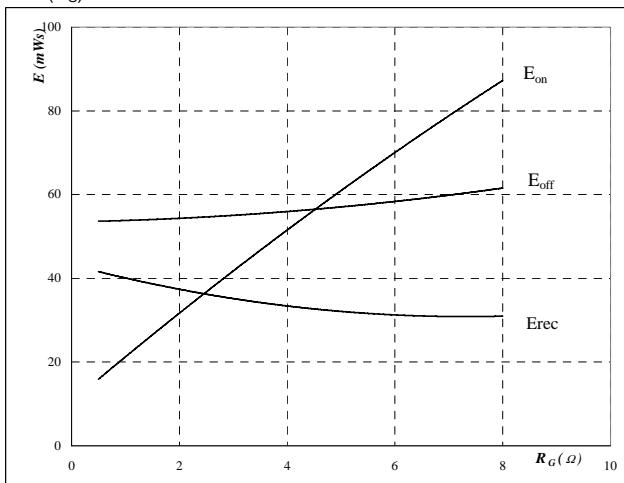
With an inductive load at

$$\begin{aligned} T_j &= 125 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 2 \quad \Omega \\ R_{goff} &= 2 \quad \Omega \end{aligned}$$

Figure 6

**Typical switching energy losses
as a function of gate resistor**

$$E = f(R_G)$$



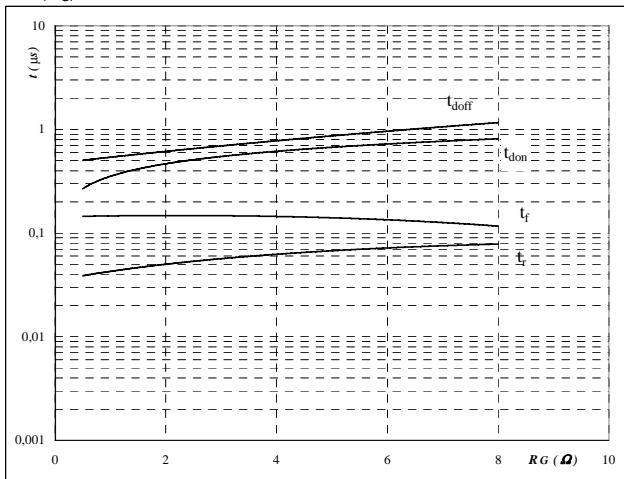
With an inductive load at

$$\begin{aligned} T_j &= 125 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_C &= 448 \quad \text{A} \end{aligned}$$

Figure 8

**Typical switching times as a
function of gate resistor**

$$t = f(R_G)$$



With an inductive load at

$$\begin{aligned} T_j &= 125 \quad ^\circ\text{C} \\ V_{CE} &= 600 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_C &= 448 \quad \text{A} \end{aligned}$$

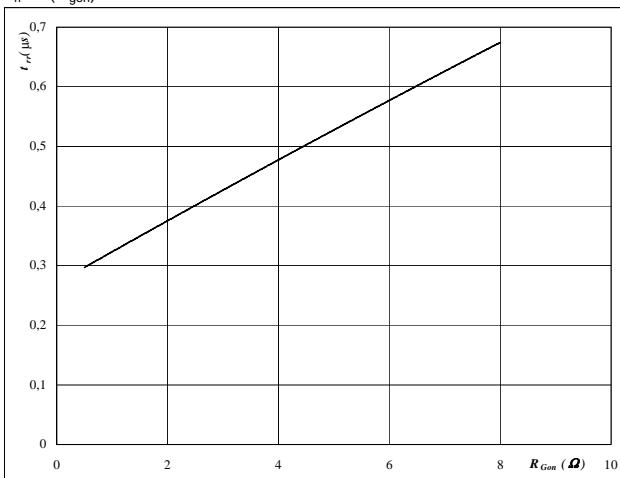
Output Inverter

Figure 9

Output inverter FRED diode

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{Gon})$$



At

$$T_j = 125 \text{ } ^\circ\text{C}$$

$$V_R = 600 \text{ V}$$

$$I_F = 448 \text{ A}$$

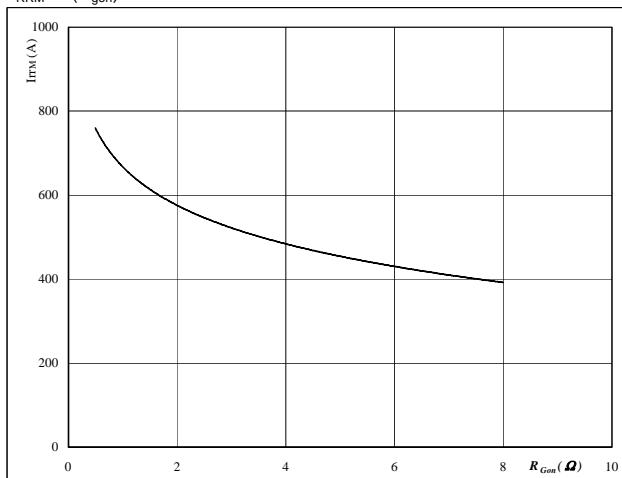
$$V_{GE} = \pm 15 \text{ V}$$

Figure 10

Output inverter FRED diode

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{Gon})$$



At

$$T_j = 125 \text{ } ^\circ\text{C}$$

$$V_R = 600 \text{ V}$$

$$I_F = 448 \text{ A}$$

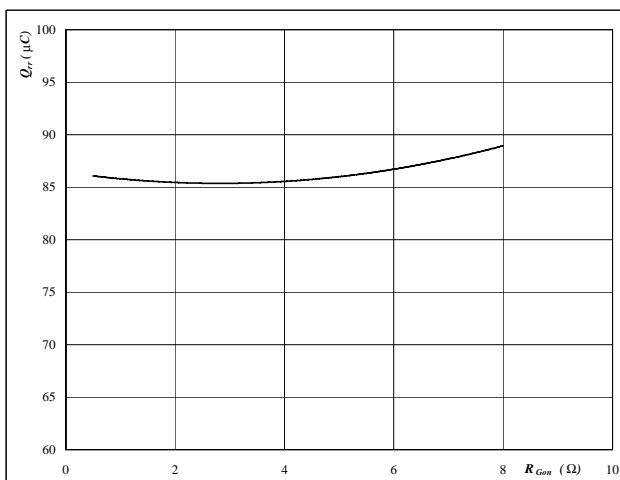
$$V_{GE} = \pm 15 \text{ V}$$

Figure 11

Output inverter FRED diode

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{Gon})$$



At

$$T_j = 125 \text{ } ^\circ\text{C}$$

$$V_R = 600 \text{ V}$$

$$I_F = 448 \text{ A}$$

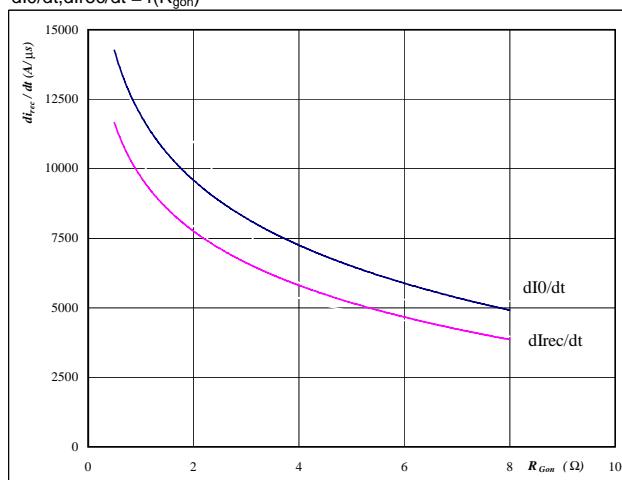
$$V_{GE} = \pm 15 \text{ V}$$

Figure 12

Output inverter FRED diode

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$dI/dt, dIrec/dt = f(R_{Gon})$$



At

$$T_j = 125 \text{ } ^\circ\text{C}$$

$$V_R = 600 \text{ V}$$

$$I_F = 448 \text{ A}$$

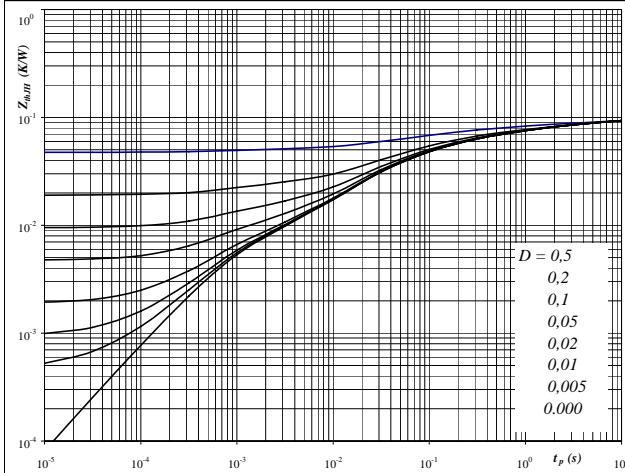
$$V_{GE} = \pm 15 \text{ V}$$

Output Inverter

Figure 13

**IGBT transient thermal impedance
as a function of pulse width**

$$Z_{thJH} = f(tp)$$



With

$$\begin{aligned} D &= tp / T \\ R_{thJH} &= 0,095 \quad \text{K/W} \end{aligned}$$

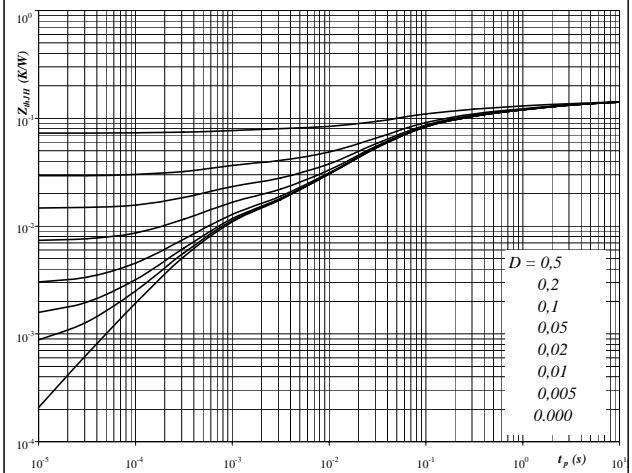
IGBT thermal model values

R (C/W)	Tau (s)
0,02	3,8E+00
0,02	5,1E-01
0,03	8,5E-02
0,02	1,8E-02
0,01	8,5E-04

Figure 14

**FRED transient thermal impedance
as a function of pulse width**

$$Z_{thJH} = f(tp)$$



With

$$\begin{aligned} D &= tp / T \\ R_{thJH} &= 0,146 \quad \text{K/W} \end{aligned}$$

FRED thermal model values

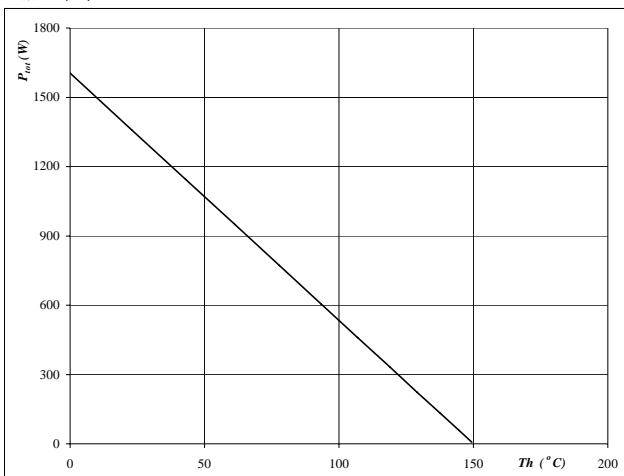
R (C/W)	Tau (s)
0,01	9,6E+00
0,03	1,7E+00
0,04	2,0E-01
0,05	3,9E-02
0,01	8,2E-03
0,01	5,4E-04

Output Inverter

Figure 15

Power dissipation as a function of heatsink temperature

$$P_{\text{tot}} = f(T_h)$$



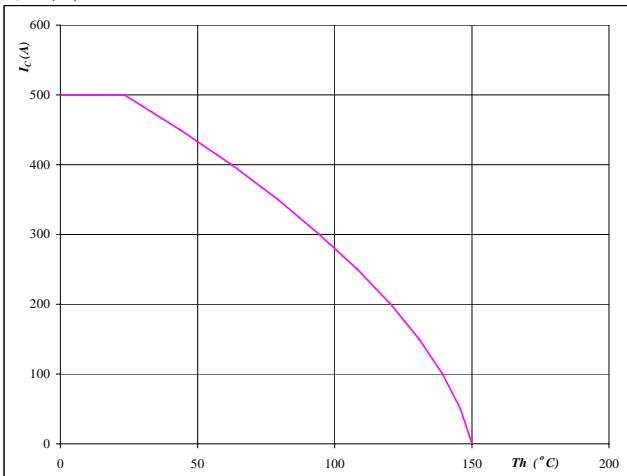
At

$$T_j = 150 \quad {}^\circ\text{C}$$

Output inverter IGBT
Figure 16

Collector current as a function of heatsink temperature

$$I_C = f(T_h)$$



At

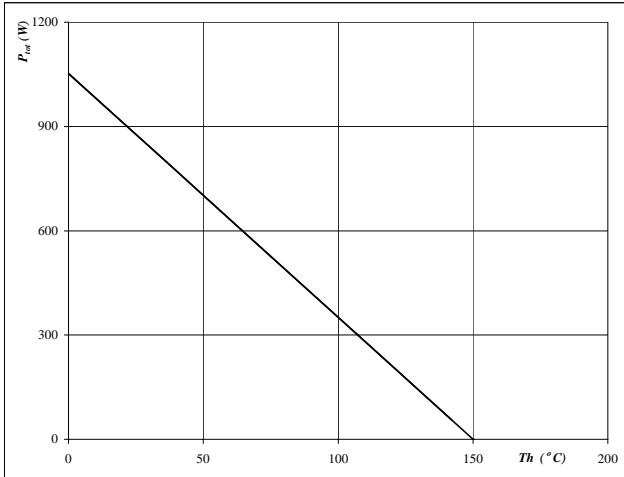
$$T_j = 150 \quad {}^\circ\text{C}$$

$$V_{GE} = 15 \quad \text{V}$$

Figure 17

Power dissipation as a function of heatsink temperature

$$P_{\text{tot}} = f(T_h)$$



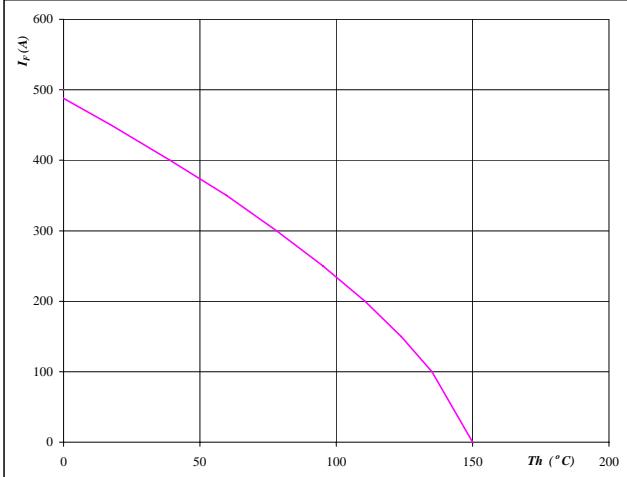
At

$$T_j = 150 \quad {}^\circ\text{C}$$

Output inverter IGBT
Figure 18

Forward current as a function of heatsink temperature

$$I_F = f(T_h)$$



At

$$T_j = 150 \quad {}^\circ\text{C}$$

Output inverter FRED

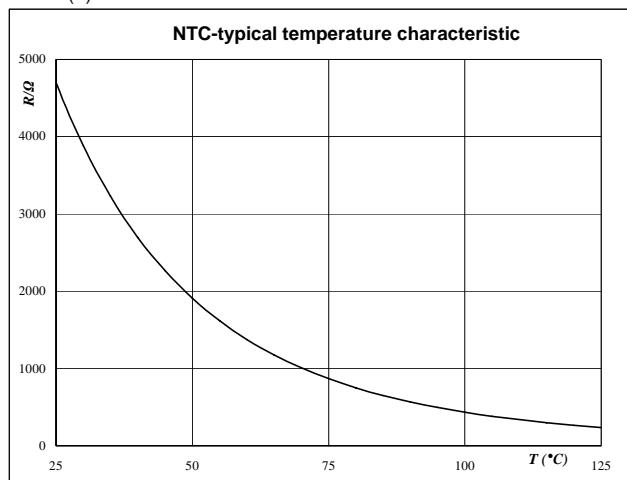
Thermistor

Figure 19

Thermistor

**Typical NTC characteristic
as a function of temperature**

$$R_T = f(T)$$



Switching Definitions Output Inverter

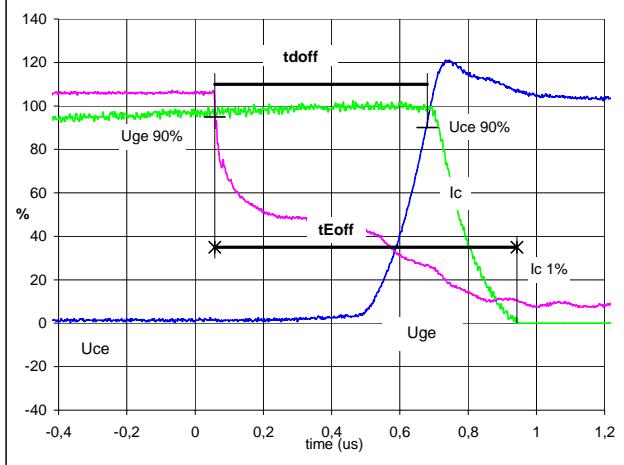
General conditions

T_j	=	125 °C
R_{gon}	=	2 Ω
R_{goff}	=	2 Ω

Figure 1

Output inverter IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff}
 $(t_{Eoff} = \text{integrating time for } E_{off})$

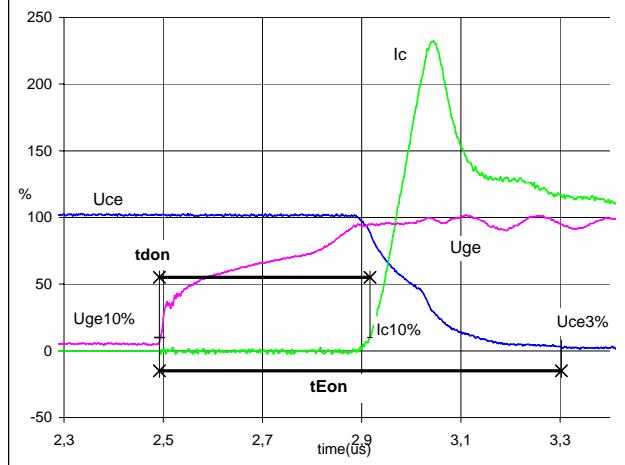


$V_{GE}(0\%) = -15$ V
 $V_{GE}(100\%) = 15$ V
 $V_C(100\%) = 600$ V
 $I_c(100\%) = 448$ A
 $t_{doff} = 0,61$ μs
 $t_{Eoff} = 0,89$ μs

Figure 2

Output inverter IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon}
 $(t_{Eon} = \text{integrating time for } E_{on})$

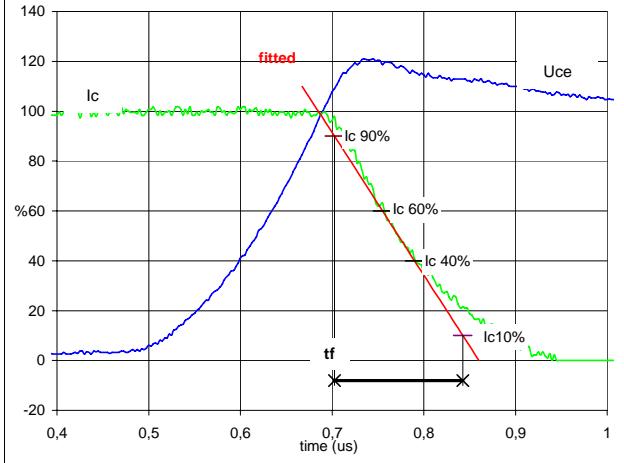


$V_{GE}(0\%) = -15$ V
 $V_{GE}(100\%) = 15$ V
 $V_C(100\%) = 600$ V
 $I_c(100\%) = 448$ A
 $t_{don} = 0,42$ μs
 $t_{Eon} = 0,81$ μs

Figure 3

Output inverter IGBT

Turn-off Switching Waveforms & definition of t_f

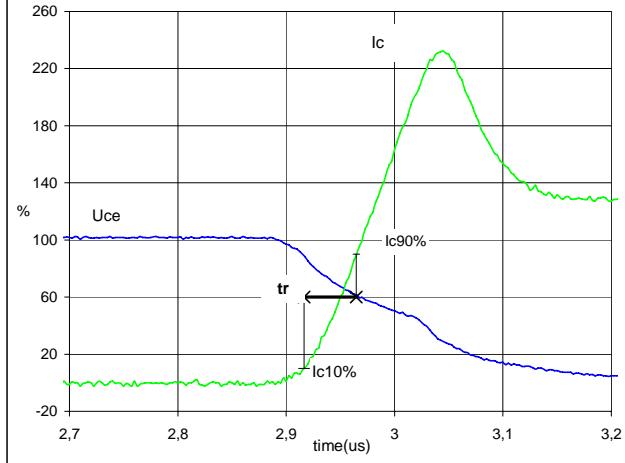


$V_C(100\%) = 600$ V
 $I_c(100\%) = 448$ A
 $t_f = 0,146$ μs

Figure 4

Output inverter IGBT

Turn-on Switching Waveforms & definition of t_r

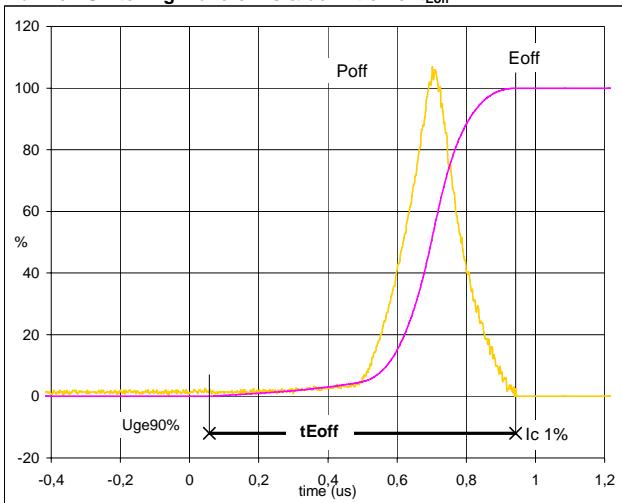


$V_C(100\%) = 600$ V
 $I_c(100\%) = 448$ A
 $t_r = 0,049$ μs

Switching Definitions Output Inverter

Figure 5

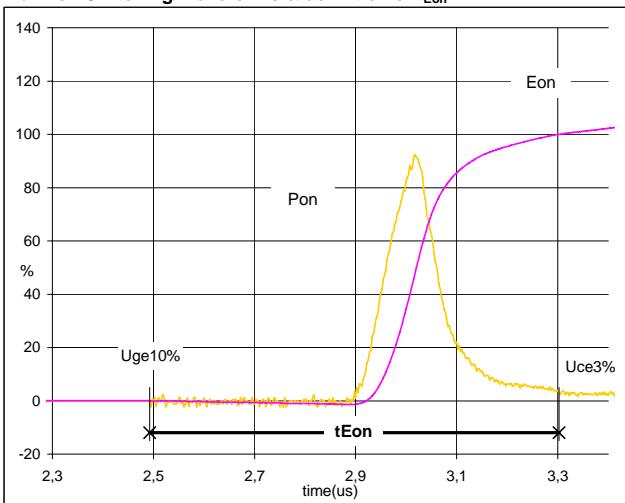
Output inverter IGBT

Turn-off Switching Waveforms & definition of t_{Eoff} 

$P_{off} (100\%) = 269,06 \text{ kW}$
 $E_{off} (100\%) = 54,21 \text{ mJ}$
 $t_{Eoff} = 0,89 \mu\text{s}$

Figure 6

Output inverter IGBT

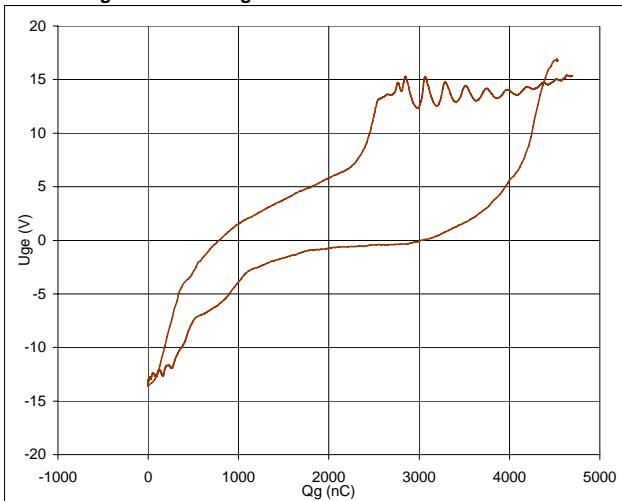
Turn-on Switching Waveforms & definition of t_{Eon} 

$P_{on} (100\%) = 269,0604 \text{ kW}$
 $E_{on} (100\%) = 31,27 \text{ mJ}$
 $t_{Eon} = 0,81 \mu\text{s}$

Figure 7

Output inverter IGBT

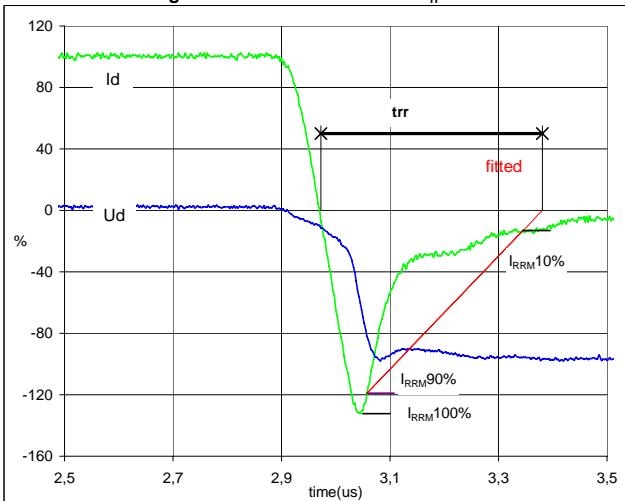
Gate voltage vs Gate charge



$V_{GEoff} = -15 \text{ V}$
 $V_{GEon} = 15 \text{ V}$
 $V_C (100\%) = 600 \text{ V}$
 $I_C (100\%) = 448 \text{ A}$
 $Q_g = 4698,4335 \text{ nC}$

Figure 8

Output inverter FRED

Turn-off Switching Waveforms & definition of t_{rr} 

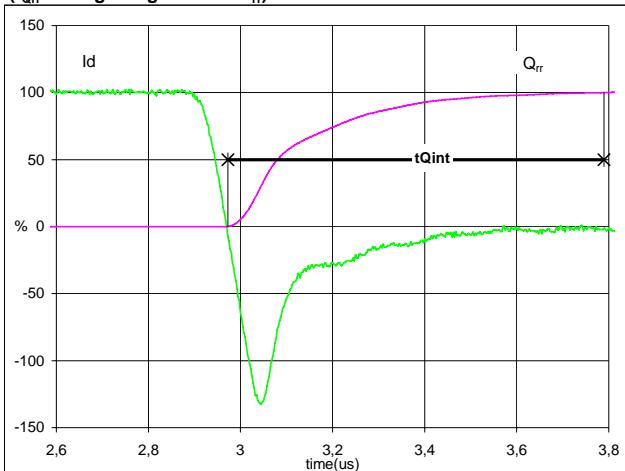
$V_d (100\%) = 600 \text{ V}$
 $I_d (100\%) = 448 \text{ A}$
 $I_{RRM} (100\%) = -598 \text{ A}$
 $t_{rr} = 0,341 \mu\text{s}$

Switching Definitions Output Inverter

Figure 9

Output inverter FRED

Turn-on Switching Waveforms & definition of t_{Qrr}
 $(t_{Qrr} = \text{integrating time for } Q_{rr})$

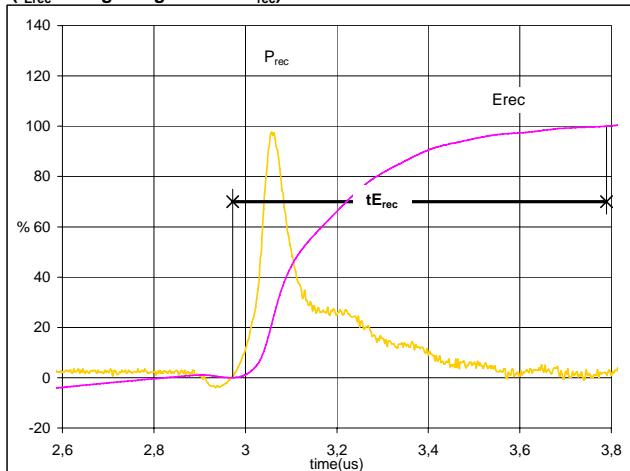


$I_d(100\%) = 448 \text{ A}$
 $Q_{rr}(100\%) = 82,939 \mu\text{C}$
 $t_{Qint} = 0,82 \mu\text{s}$

Figure 10

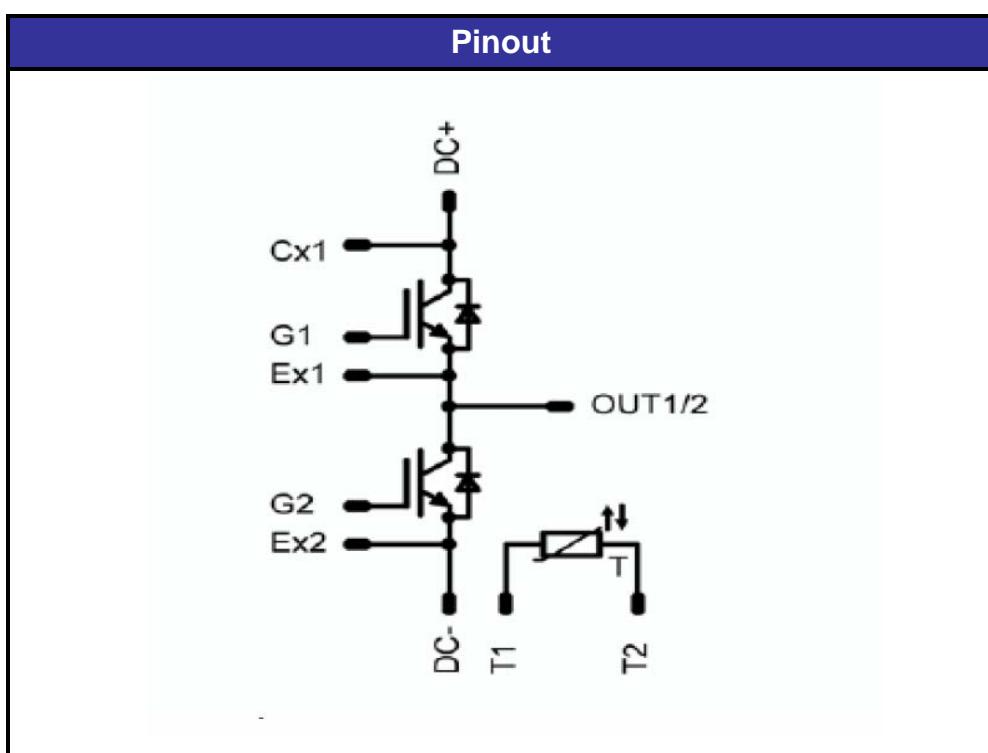
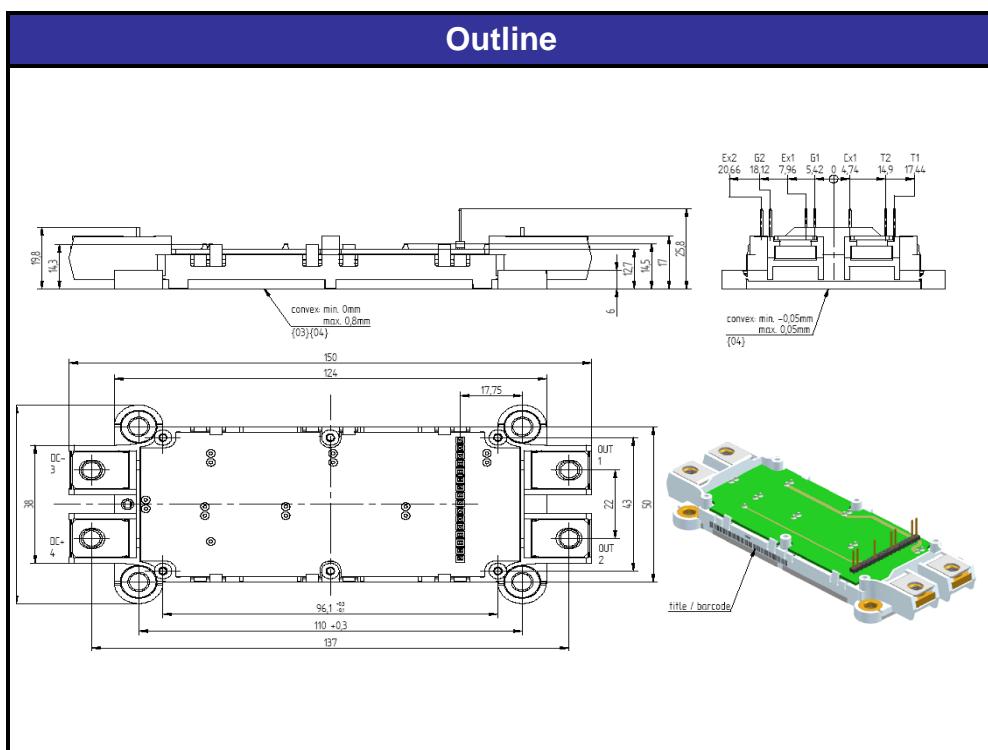
Output inverter FRED

Turn-on Switching Waveforms & definition of t_{Erec}
 $(t_{Erec} = \text{integrating time for } E_{rec})$



$P_{rec}(100\%) = 269,0604 \text{ kW}$
 $E_{rec}(100\%) = 36,011 \text{ mJ}$
 $t_{Erec} = 0,82 \mu\text{s}$

Package Outline and Pinout



PRODUCT STATUS DEFINITIONS

Datasheet Status	Product Status	Definition
Target	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice. The data contained is exclusively intended for technically trained staff.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data may be published at a later date. Vincotech reserves the right to make changes at any time without notice in order to improve design. The data contained is exclusively intended for technically trained staff.
Final	Full Production	This datasheet contains final specifications. Vincotech reserves the right to make changes at any time without notice in order to improve design. The data contained is exclusively intended for technically trained staff.

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Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

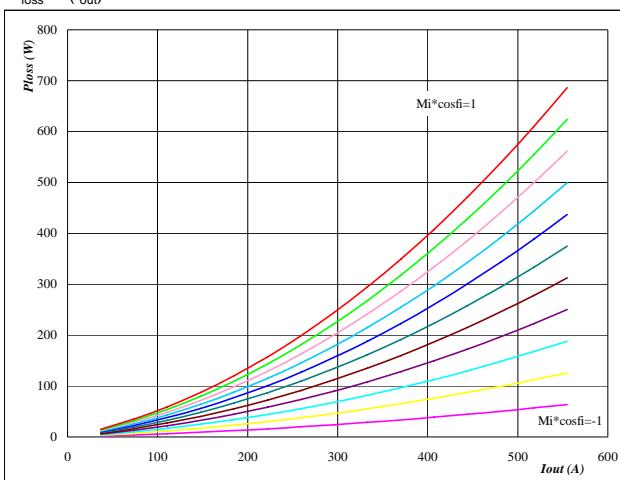
1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

flowPHASE 3
Output Inverter Application
1200V/450A
General conditions
3phase SPWM

V_{GEon}	= 15 V
V_{GEoff}	= -15 V
R_{gon}	= 2 Ω
R_{goff}	= 2 Ω

Figure 1**Typical average static loss as a function of output current**

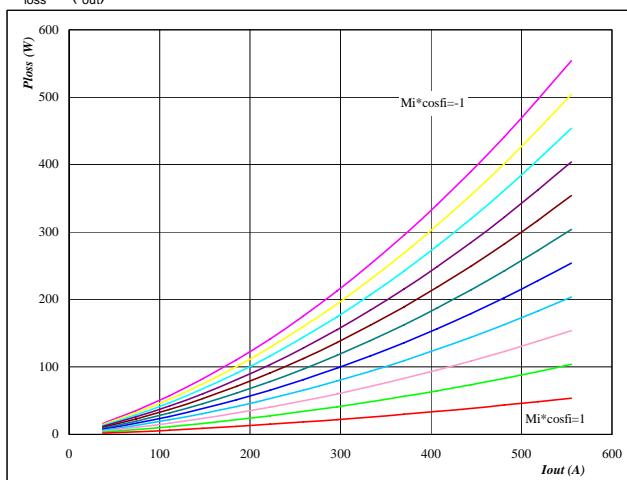
$$P_{loss} = f(I_{out})$$

**At** $T_j = 125^\circ\text{C}$

Mi*cosfi from -1 to 1 in steps of 0,2

IGBT**Figure 2****Typical average static loss as a function of output current**

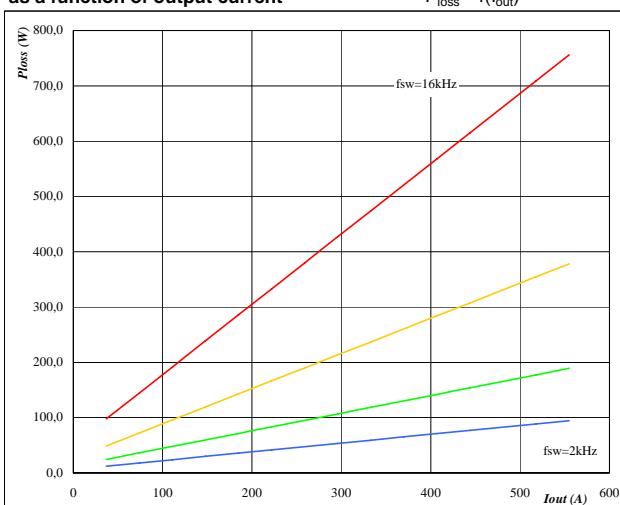
$$P_{loss} = f(I_{out})$$

**At** $T_j = 125^\circ\text{C}$

Mi*cosfi from -1 to 1 in steps of -0,2

FRED**Figure 3****Typical average switching loss as a function of output current**

$$P_{loss} = f(I_{out})$$

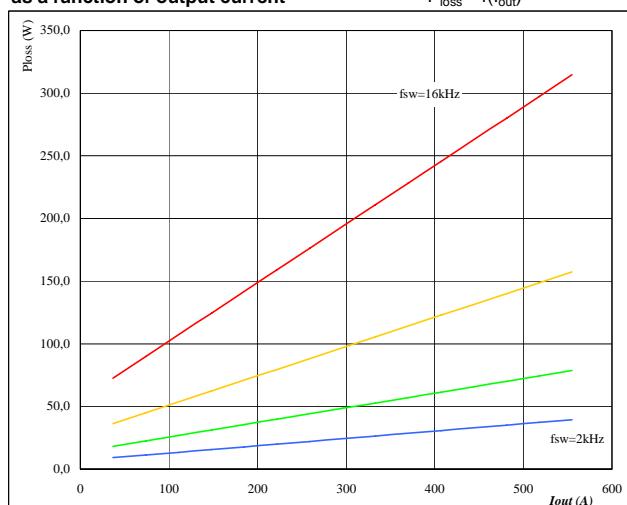
**At** $T_j = 125^\circ\text{C}$

DC link = 600 V

fsw from 2 kHz to 16 kHz in 2 steps

IGBT**Figure 4****Typical average switching loss as a function of output current**

$$P_{loss} = f(I_{out})$$

**At** $T_j = 125^\circ\text{C}$

DC link = 600 V

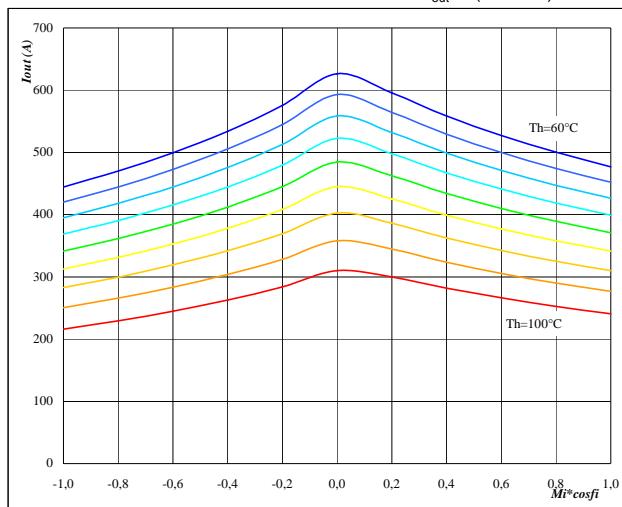
fsw from 2 kHz to 16 kHz in 2 steps

FRED

flowPHASE 3
Output Inverter Application
1200V/450A
Figure 5
**Typical available 50Hz output current
as a function $M_i \cdot \cos f_i$**

Phase

$$I_{out} = f(M_i \cdot \cos f_i)$$

**At** $T_j = 125 \text{ } ^\circ\text{C}$

DC link = 600 V

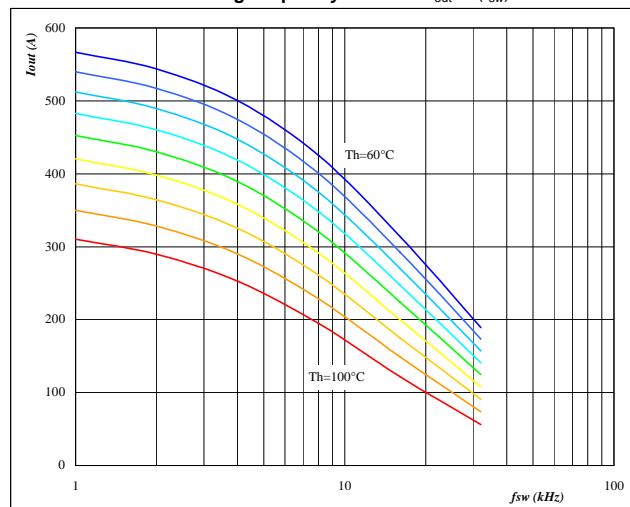
 $f_{sw} = 4 \text{ kHz}$

Th from 60 °C to 100 °C in steps of 5 °C

Figure 6
**Typical available 50Hz output current
as a function of switching frequency**

Phase

$$I_{out} = f(f_{sw})$$

**At** $T_j = 125 \text{ } ^\circ\text{C}$

DC link = 600 V

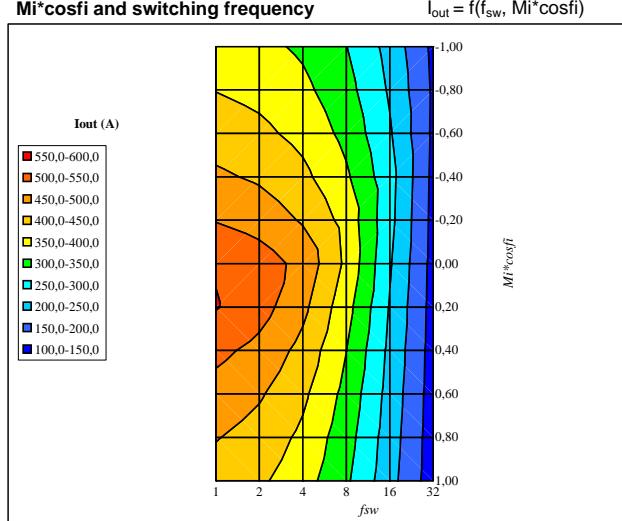
 $M_i \cdot \cos f_i = 0,8$

Th from 60 °C to 100 °C in steps of 5 °C

Figure 7
**Typical available 50Hz output current as a function of
 $M_i \cdot \cos f_i$ and switching frequency**

Phase

$$I_{out} = f(f_{sw}, M_i \cdot \cos f_i)$$

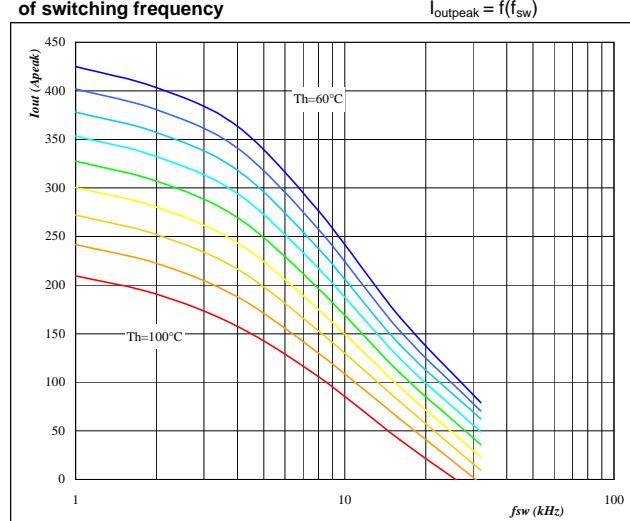
**At** $T_j = 125 \text{ } ^\circ\text{C}$

DC link = 600 V

 $T_h = 80 \text{ } ^\circ\text{C}$ **Figure 8**
**Typical available 0Hz output current as a function
of switching frequency**

Phase

$$I_{outpeak} = f(f_{sw})$$

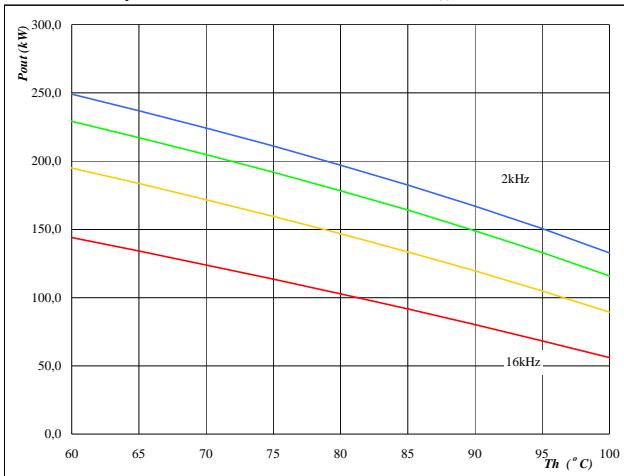
**At** $T_j = 125 \text{ } ^\circ\text{C}$

DC link = 600 V

Th from 60 °C to 100 °C in steps of 5 °C

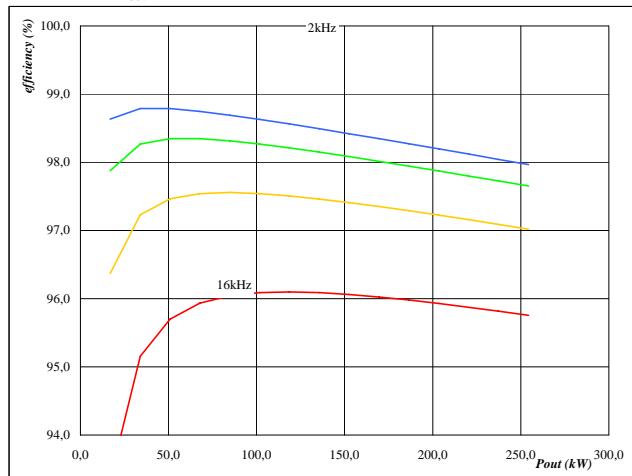
flowPHASE 3
Output Inverter Application
1200V/450A

Figure 9 Inverter
Typical available peak output power as a function of heatsink temperature
 $P_{out}=f(T_h)$



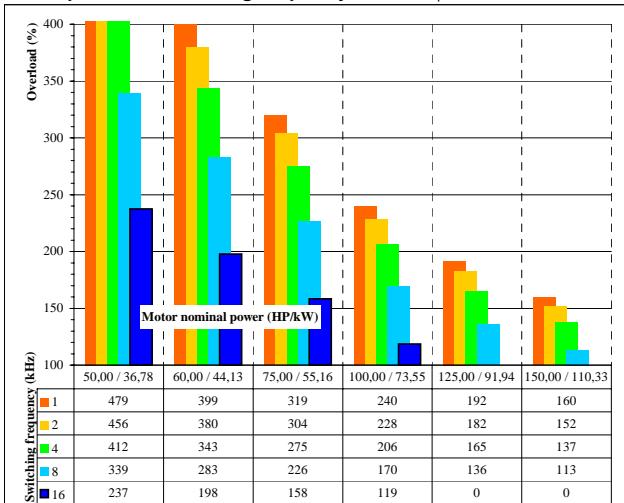
At
 $T_j = 125 \text{ } ^\circ\text{C}$
DC link = 600 V
 $M_i = 1$
 $\cos \phi = 0,80$
fsw from 2 kHz to 16 kHz in 2 steps

Figure 10 Inverter
Typical efficiency as a function of output power
efficiency=f(P_{out})



At
 $T_j = 125 \text{ } ^\circ\text{C}$
DC link = 600 V
 $M_i = 1$
 $\cos \phi = 0,80$
fsw from 2 kHz to 16 kHz in 2 steps

Figure 11 Inverter
Typical available overload factor as a function of motor power and switching frequency
 $P_{peak} / P_{nom}=f(P_{nom}, f_{sw})$



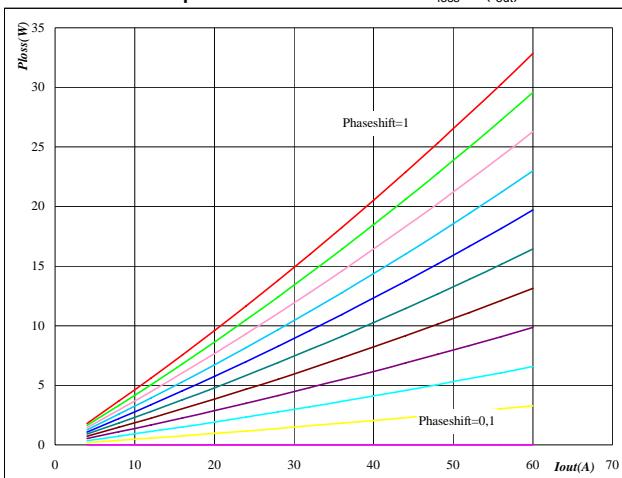
At
 $T_j = 125 \text{ } ^\circ\text{C}$
DC link = 600 V
 $M_i = 1$
 $\cos \phi = 0,8$
fsw from 1 kHz to 16 kHz in 2 steps
 $Th = 80 \text{ } ^\circ\text{C}$
Motor eff = 0,85

flowPHASE 3
ZVS Application
1200V/450A
General conditions
Phase shifted ZVS

V_{GEon}	= 15 V
V_{GEoff}	= -15 V
R_{gon}	= 2 Ω
R_{goff}	= 2 Ω

Figure 1
**Typical static loss of shifted switch
as a function of output current**

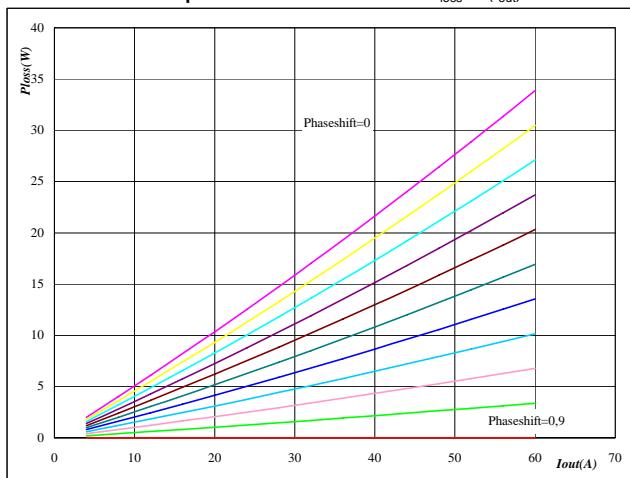
$$P_{loss} = f(I_{out})$$

**At** $T_j = 125^\circ\text{C}$

Phaseshift from 0,1 to 1 in steps of 0,1

IGBT**Figure 2**
**Typical static loss of shifted switch
as a function of output current**

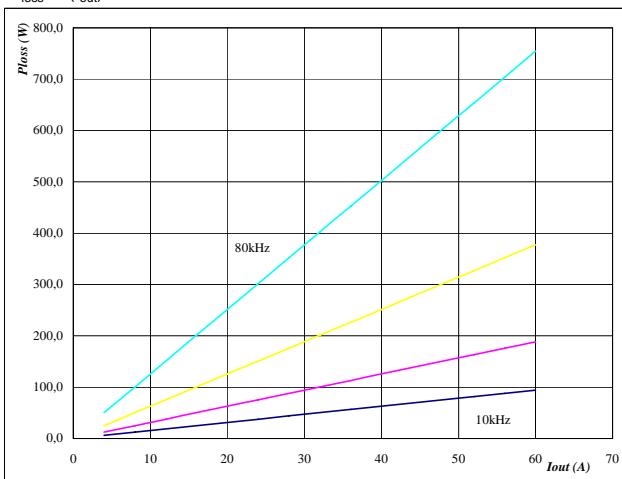
$$P_{loss} = f(I_{out})$$

**At** $T_j = 125^\circ\text{C}$

Phaseshift from 0,1 to 1 in steps of 0,1

FRED**Figure 3**
Typical switching loss as a function of output current

$$P_{loss} = f(I_{out})$$

**At** $T_j = 125^\circ\text{C}$

DC link = 600 V

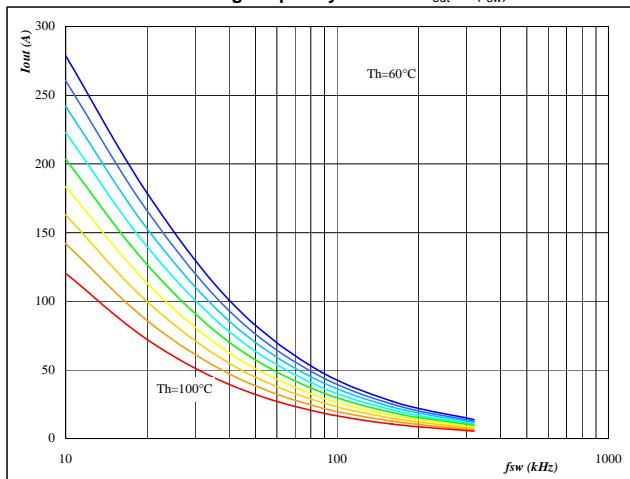
 $I_{outpk}/I_{out} = 1,3$

Phaseshift = 1

fsw from 10 kHz to 80 kHz in 2 steps

IGBT**Figure 4**
**Typical available output current
as a function of switching frequency**

$$I_{out} = f(f_{sw})$$

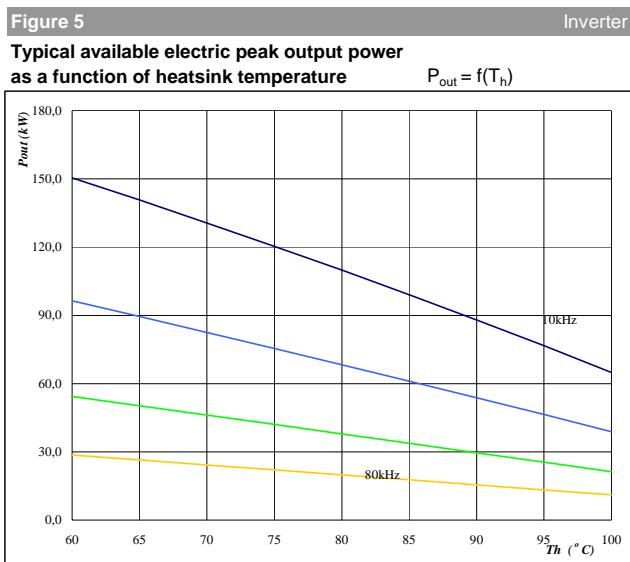
Phase**At** $T_j = 125^\circ\text{C}$

DC link = 600 V

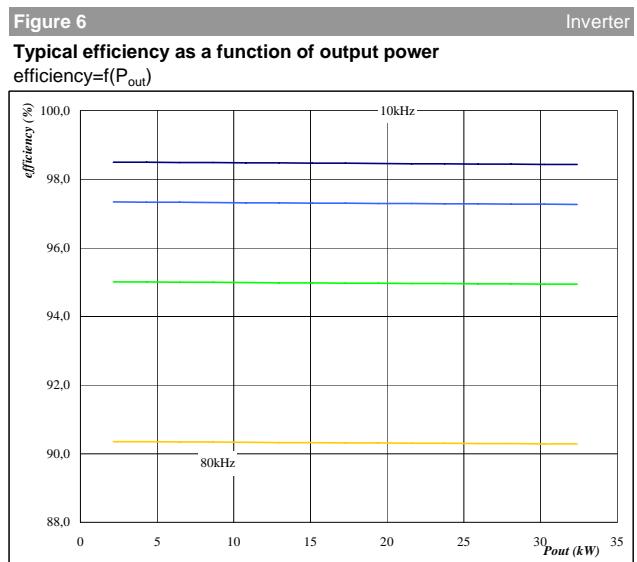
 $I_{outpk}/I_{out} = 1,3$

Phaseshift = 1

Th from 60 °C to 100 °C in steps of 5 °C

flowPHASE 3
ZVS Application
1200V/450A


At
 $T_j = 125 \text{ } ^\circ\text{C}$
DC link = 600 V
 $I_{outpk}/I_{out} = 1,3$
Phaseshift = 1
fsw from 10 kHz to 80 kHz in 2 steps



At
 $T_j = 125 \text{ } ^\circ\text{C}$
DC link = 600 V
 $I_{outpk}/I_{out} = 1,3$
Phaseshift = 1
fsw from 10 kHz to 80 kHz in 2 steps